

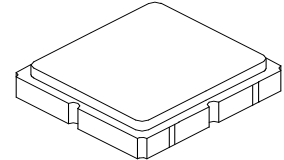


AEC-Q200

This component was always RoHS compliant from the first date of manufacture.

**SF2413E**

**866.5 MHz  
SAW Filter**



**SM3030-6**

- Surface Mount 3.0 x 3.0 mm Package
- Complies with Directive 2002/95/EC (RoHS)



**Absolute Maximum Ratings**

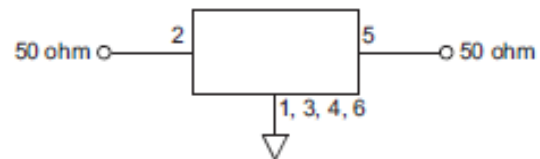
Rating	Value	Units
Input Power Level	15	dBm
DC Voltage on any Non-ground Terminal	6	V
Operable Temperature	-40 to +125	°C
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C

**Electrical Characteristics**

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	$f_c$			866.5		MHz
Insertion Loss, (863 to 870 MHz)	IL			3.0	3.8	dB
Amplitude Ripple, (863 to 870 MHz)				1.5	2.0	
VSWR (863 to 870 MHz)				1.8	2.2	
Attenuation, Referenced from 0 dB:						dB
10 to 830 MHz			36	41		
830 to 845 MHz			32	37		
880 to 884 MHz			20	25		
884 to 887 MHz			36	41		
887 to 965 MHz			45	50		
965 to 2000 MHz			40	45		
Temperature Coefficient of Frequency				-36		ppm/k
Case Style	SM3030-6 3.0 x 3.0 mm Nominal Footprint					
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	7W, YWWS					

**Electrical Connections**

Connection	Terminals
Input	2
Output	5
Case Ground	All others

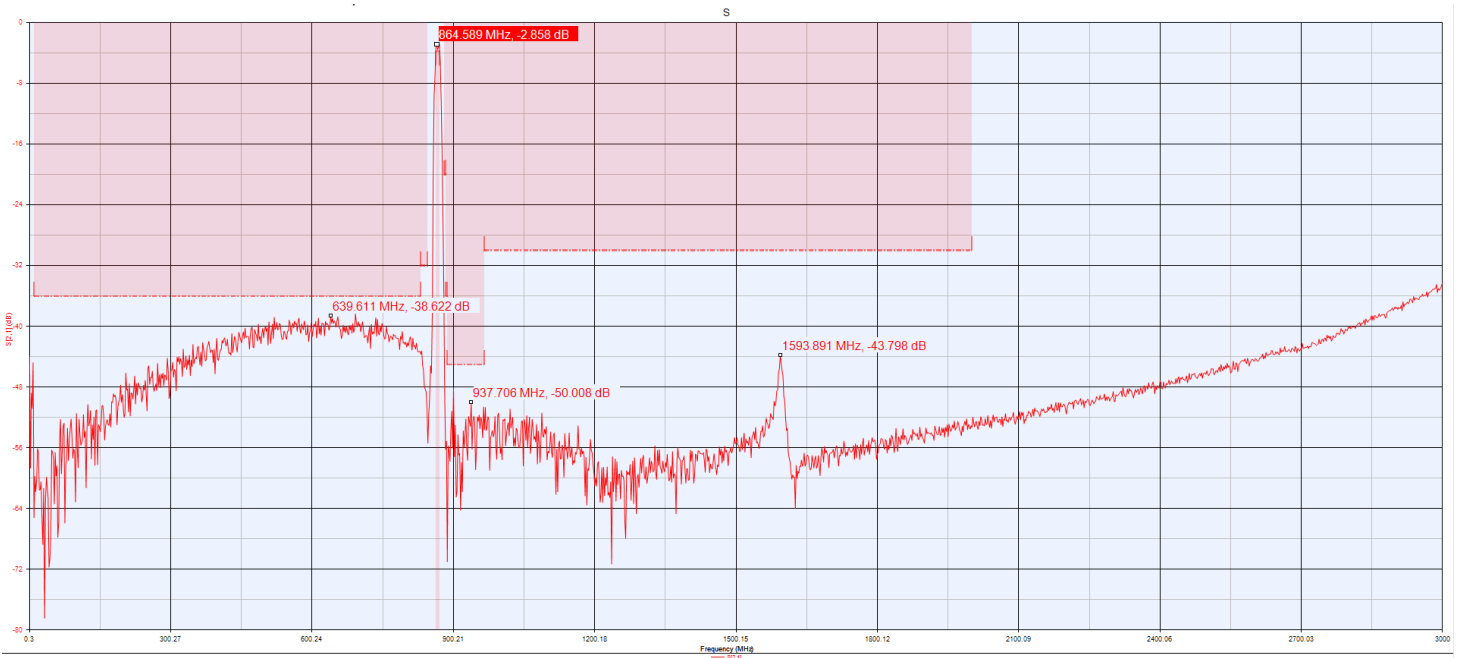
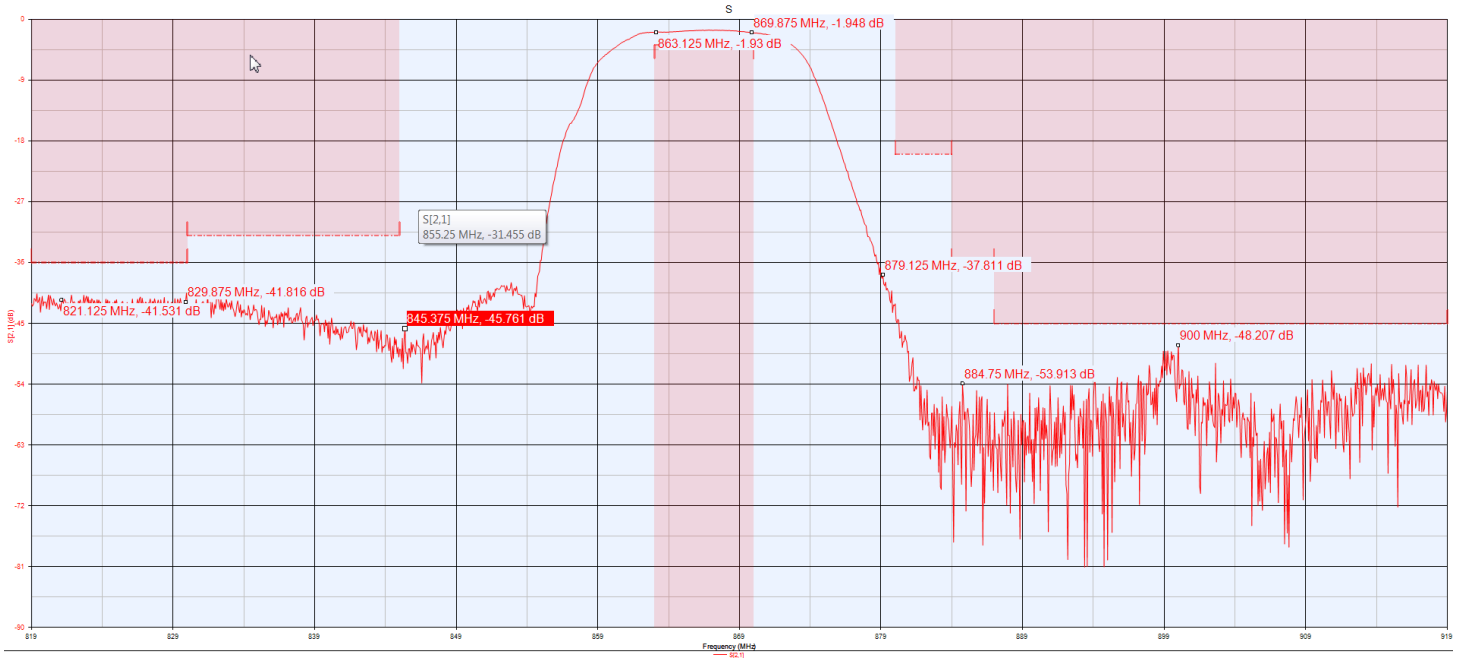


**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

**NOTES:**

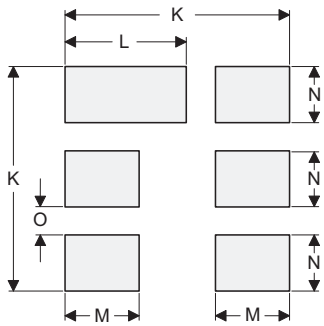
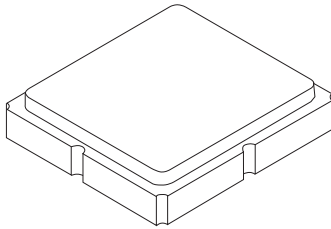
1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.

# Frequency Characteristics



# SM3030-6 Case

## 6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint



PCB Footprint Top View

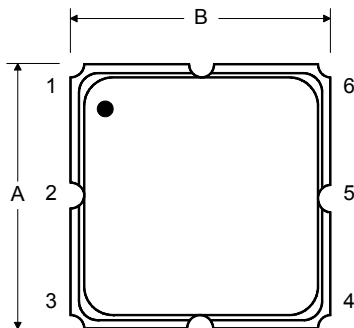
### Case and PCB Footprint Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	-	3.00	-	-	0.118	-
B	-	3.00	-	-	0.118	-
C	-	-	1.30	-	-	0.051
D	-	-	0.90	-	-	0.035
E	-	2.80	-	-	0.110	-
F	-	1.60	-	-	0.063	-
G	-	0.85	-	-	0.033	-
H	-	1.50	-	-	0.059	-
I	-	0.60	-	-	0.024	-
J	-	1.30	-	-	0.051	-
K	-	3.20	-	-	0.126	-
L	-	1.70	-	-	0.067	-
M	-	1.05	-	-	0.041	-
N	-	0.81	-	-	0.032	-
O	-	0.38	-	-	0.015	-

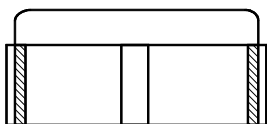
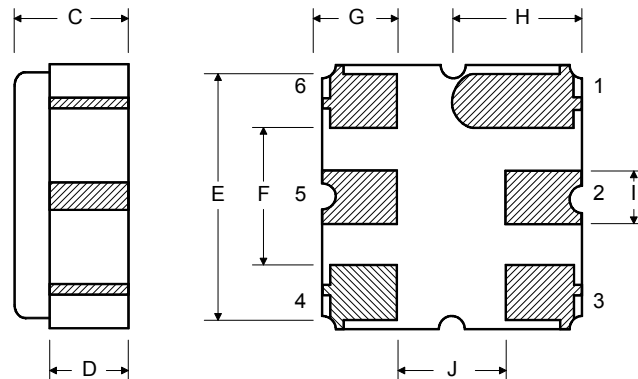
### Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 $\mu\text{m}$ Gold over 1.27 to 8.89 $\mu\text{m}$ Nickel
Lid Plating	2.0 to 3.0 $\mu\text{m}$ Nickel
Body	$\text{Al}_2\text{O}_3$ Ceramic
Pb Free	

### TOP VIEW

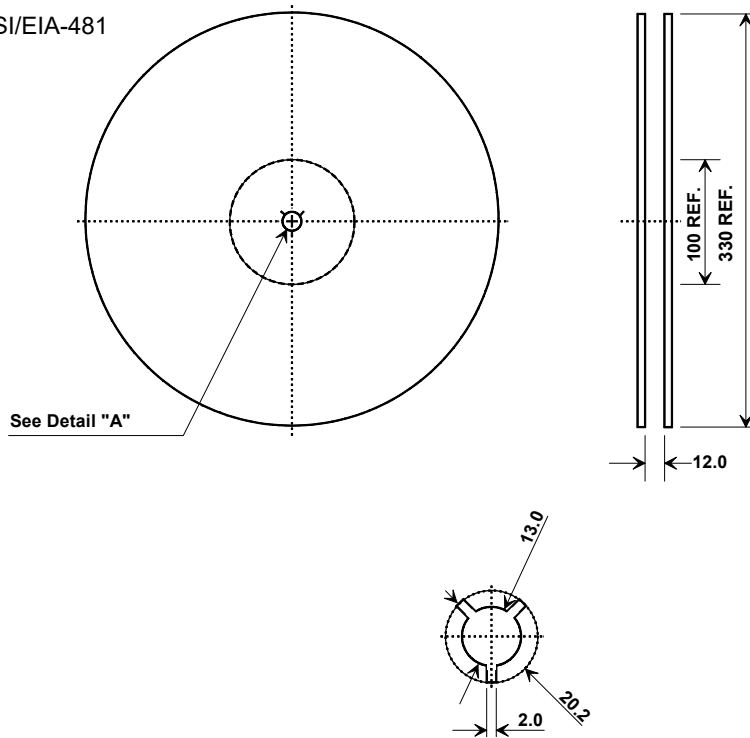


### BOTTOM VIEW



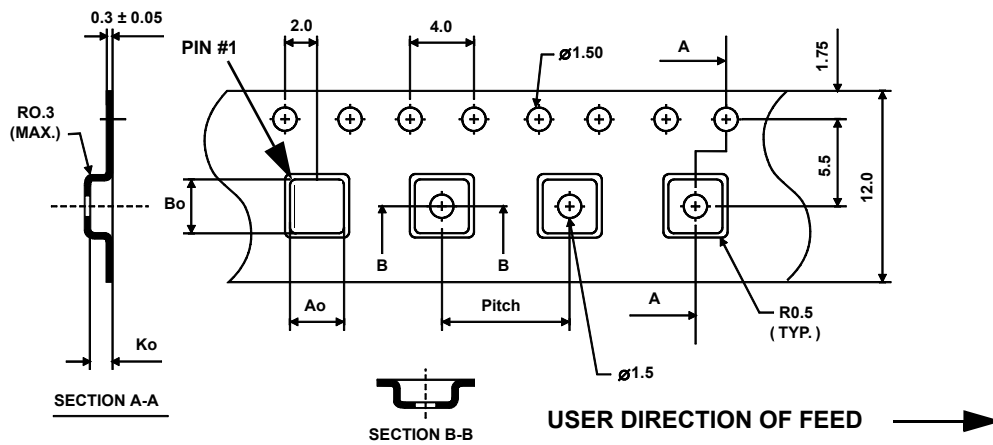
## Tape and Reel Specifications

Tape and Reel Standard per ANSI/EIA-481



### COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	3.35 mm
Bo	3.35 mm
Ko	1.40 mm
Pitch	8.0 mm
W	12.0 mm



## Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
4. Time: 5 times maximum.

